

N-Channel 100-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)		
100	0.015 at V _{GS} = 10 V	68 ^a		

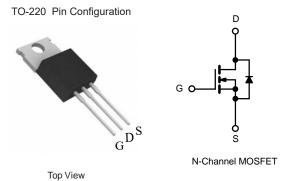
FEATURES

- DT-Trench Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % Rg Tested

APPLICATIONS

• Isolated DC/DC Converters





ABSOLUTE MAXIMUM RATINGS	$\Gamma_{-} = 25 ^{\circ} \Omega_{-}$ unless other	orwise noted		
Parameter	$T_{\rm C} = 23$ °C, unless of h	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	100		
Gate-Source Voltage	V _{GS}	± 20	V	
Continuous Drain Current ($T_1 = 175 ^{\circ}C$)	T _C = 25 °C	L	68 ^a	
Commodus Drain Current $(T_j = T/5 C)$	T _C = 125 °C	– I _D –	41 ^a	A
Pulsed Drain Current		I _{DM}	210	A .
Avalanche Current	L = 0.1 mH	I _{AS}	65	
Single Pulse Avalanche Energy ^b	L = 0.1 mm	E _{AS}	78	mJ
	T _C = 25 °C	– P _D –	395 ^c	w
Maximum Power Dissipation ^b	$T_A = 25 \ ^{\circ}C^{d}$	٢D	3.82	VV

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Limit	Unit		
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	38	°C/W		
Junction-to-Case (Drain)		R _{thJC}	0.4	0/10		

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

Operating Junction and Storage Temperature Range

°C

- 55 to 175

T_J, T_{stg}

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 V, I_{D} = 250 \mu A$	100			V
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		3	v
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		$V_{DS} = 80 \text{ V}$, $V_{GS} = 0 \text{ V}$			1	μA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			50	
		$V_{DS} = 80 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_{J} = 175 \text{ °C}$			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	68			Α
		V _{GS} = 10 V, I _D = 20 A		0.015	0.020	0
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 4.5 V, I _D = 15 A		0.022	0.028	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 80 V, I _D = 20 A		100		S
Dynamic ^b						
Input Capacitance	C _{iss}			2480		pF
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		230		
Reverse Transfer Capacitance	C _{rss}			110		
Total Gate Charge ^c	Qg			90	130	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		23		nC
Gate-Drain Charge ^c	Q _{gd}			34		
Gate Resistance	R _g		0.5	1.7	3.3	Ω
Turn-On Delay Time ^c	t _{d(on)}			24	35	
Rise Time ^c	t _r	V_{DD} = 50 V, R_L = 1.5 Ω		230	330	
Turn-Off Delay Time ^c	t _{d(off)}	$\rm I_D \cong 20$ A, $\rm V_{GEN}$ = 10 V, $\rm R_g$ = 2.5 Ω		46	70	– ns
Fall Time ^c	t _f			205	300	
Source-Drain Diode Ratings and Cha	aracteristics 7	Γ _C = 25 °C ^b				
Continuous Current	۱ _S				68	^
Pulsed Current	I _{SM}				210	A
Forward Voltage ^a	V _{SD}	$I_{F} = 20 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		1.0	1.5	V
Reverse Recovery Time	t _{rr}			133	200	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 20 A, di/dt = 100 A/μs		8	12	А
Reverse Recovery Charge	Q _{rr}			0.53	1.2	μC

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

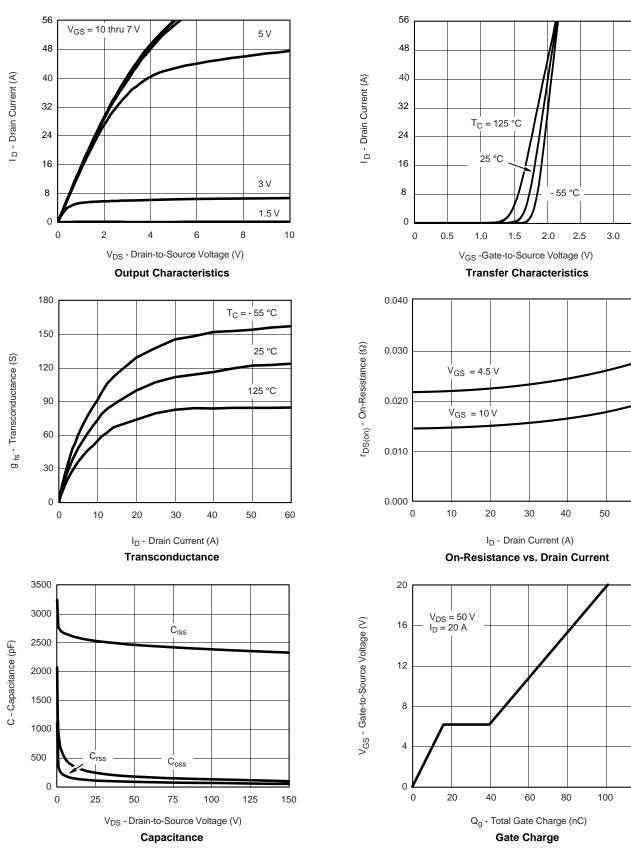


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3.5

60

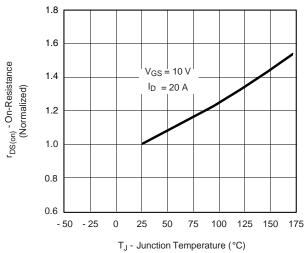




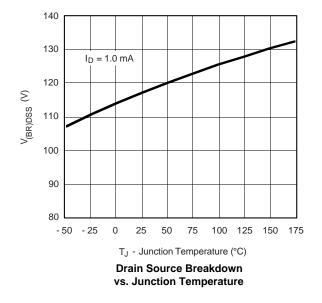
120

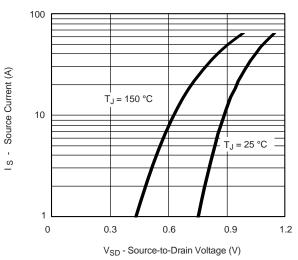
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

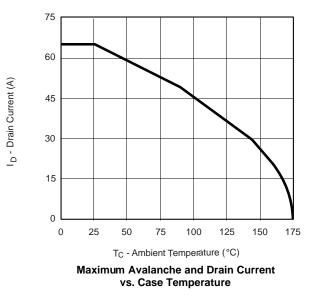








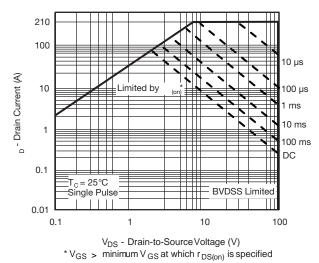
Source-Drain Diode Forward Voltage



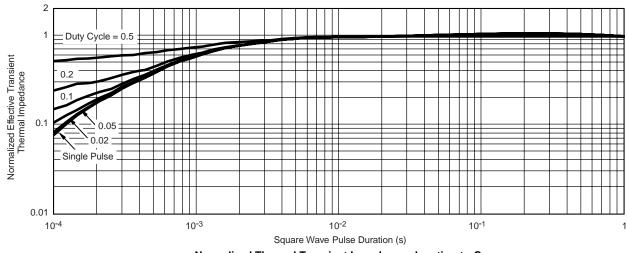


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THERMAL RATINGS



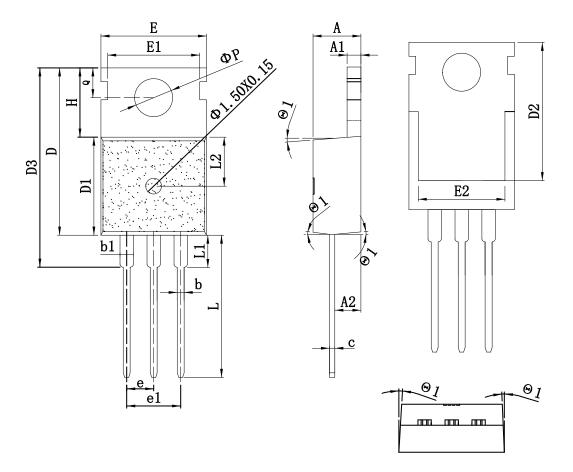




Normalized Thermal Transient Impedance, Junction-to-Case



TO-220_3L-A PACKAGE OUTLINE

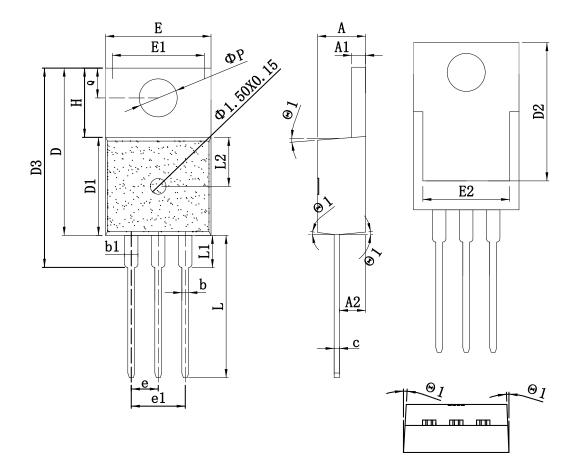


COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL		mm		SYMBOL mm			
SIMBOL	MIN	TYP	MAX	SIMBOL	MIN	TYP	MAX
А	4.15	4.50	4.80	E1	8.25	8.70	9.15
A1	1.15	1.30	1.50	E2	7.20	8.00	8.80
A2	2.10	2.40	2.65	e	2.38	2.54	2.74
b	0.65	0.80	1.00	e1	5.08REF		
b1	1.10	1.33	1.80	Н	6.20	6.50	6.90
с	0.35	0.50	0.65	L	12.75	13.28	13.70
D	14.25	15.75	16.15	L1	-	-	3.50
D1	8.70	9.20	9.60	L2	2.30	4.65	7.00
D2	12.30	13.10	13.85	φP	3.40	3.65	3.85
D3	16.20	18.80	20.60	Q	2.50	2.80	3.00
Е	8.68	10.02	11.00	θ	2°	-	7°



TO-220_3L-B PACKAGE OUTLINE



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL		mm SYMBOL		SYMPOL	mm			
SINDOL	MIN	TYP	MAX	SIMBOL	MIN	TYP	MAX	
А	4.15	4.50	4.80	E1	8.25	8.70	9.15	
A1	1.15	1.30	1.50	E2	7.20	8.00	8.80	
A2	2.10	2.40	2.65	е	2.38	2.54	2.74	
b	0.65	0.80	1.00	e1	5.08REF			
b1	1.10	1.33	1.80	Н	6.20	6.50	6.90	
с	0.35	0.50	0.65	L	12.75	13.28	13.70	
D	14.25	15.75	16.15	L1	-	-	3.50	
D1	8.70	9.20	9.60	L2	2.30	4.65	7.00	
D2	12.30	13.10	13.85	φP	3.40	3.65	3.85	
D3	16.20	18.80	20.60	Q	2.50	2.80	3.00	
Е	8.68	10.02	11.00	θ	2°	-	7°	



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